Application D	Attorn	ey Docket N	umber	MTI-31608				
Application D	ata Sileet 37	CFR I.	Applic	ation Number	er	10/068,159		
Title of Invention	Stacked Die is	n Die BGA F	Package					·
bibliographic data arra	nged in a format s e completed elect	pecified by th ronically and	e United States submitted to t	Patent and Tra	ademark O	being submitted. The following fifice as outlined in 37 CFR 1.76 mat using the Electronic Fifing		
Secrecy Ord	er 37 CFR	5.2						
Portions or all	of the applicatio	n associate				may fall under a Secrecy r may not be filed electro		suant to
Applicant Inf	ormation:							
Applicant 1								
Applicant Autho	rity •Inventor	OLegal	Representati	ve under 35	J.S.C. 11	7 Party of Interest up	nder 35 U.S.	C. 118
Prefix Given Na			Middle Na	me		Family Name		Suffix
Hock Chu	n					Tan		
Residence Infor	mation (Select	t One)	US Residen	cy No	n US Res	idency Active US Mil	itary Service	
City Singapore		Co	ountry Of R	esidence	SG			
Citizenship unde	r 37 CFR 1.41	(b) i so	3					
Mailing Address		`						
Address 1	- i	59. Pasir Ri	s St. 13, #07-	09				
Address 2		-						
City Singa				Stat	e/Provin	00		
			-					
Postal Code	510159			Country	SG			
Applicant 2								
Applicant Autho		OLegal	Representati	ve under 35 l	J.S.C. 117	Party of Interest u	nder 35 U.S.	C. 118
Prefix Given Na	me		Middle Na	ıme		Family Name		Suffix
Thiam Chy	re					Lim		
Residence Infor	mation (Select	One)	US Residen	cy 💿 No	n US Res	idency Active US Mil	itary Service	
City Singapore		Co	ountry Of R	esidencei	SG			
Citizenship unde	r 37 CFR 1.41	(b)i so	3					
Mailing Address	of Applicant:							
Address 1	Block 5	1, Tampines	s Ave 1, #10-0	06				
Address 2	The Tro	pica						
City Singa	pore			Stat	e/Provin	ce		
Postal Code	529771			Country	SG			
Applicant 3	1			1	1			
Applicant Sutho	eity () Inventor	OLegal	Representati	ve under 35 l	J.S.C. 117	Party of Interest ur	nder 35 U.S.	C. 118
		1034						Suffi
Prefix Given Na	me							
Prefix Given Na			Middle Na	ime		Family Name		Julia
Victor Che Residence Infor	r Khng	One)	US Residen		n US Res	Tan	itan/ Service	

	Under the P	aperwork Reducti	on Act of 1	995, no p	ersons are re	quired to respon	U.S. Pat d to a collec	ent and T tion of Inf	rademark Office; U.S. DEPARTMENT OF of ormation unless it contains a valid OMB cor	OMMERCE itrol number	
A 12	D.	4- 014	7.05	4 70	Attorn	ey Docket I	Number	MTI-	31608		
Applica	ition Da	ta Sheet 3	CFF	(1.76	Applic	ation Numb	er	10/068,159			
Title of In	vention	Stacked Die	in Die E	GA Pac	kage						
Citizensi	nip under	37 CFR 1.4	1(b) i	SG							
Mailing A	Address o	f Applicant	:			-		8			
Address	1	Block	56, #12-	31 Choa	Chu Kang	North 6					
Address	2	Yew M	lei Gree	ı							
City	Singapo	ore				Sta	te/Provi	псе			
Postal C	Postal Code 688577				-	Country	SG				
Applican	t 4										
		ty inventor	Or	egal Re	presentativ	e under 35	U.S.C. 1	17	Party of Interest under 35 U.S	.C. 118	
	iven Nan			N	liddle Na	me		Fan	nily Name	Suffix	
C	hee Peng							Neo			
Residen	ce Inform	ation (Selec	t One)	O U	Residence	y 💿 N	on US Re	sidenc	y Active US Military Service		
City Si	ngapore			Cour	try Of Re	sidencei	SG				
Citizensi	nip under	37 CFR 1.4	1(b) i	SG							
Mailing A	Address o	f Applicant									
Address	1	Block (643, Yisi	nun St. 6	51, #07-27	0					
Address	2										
City	Singapo	re	•			Sta	te/Provi	nce			
Postal C	ode	76064	3			Country	SG				
Applican	+ 5										
		ty •Inventor	Or	egal Re	presentativ	e under 35	U.S.C. 11	17	Party of Interest under 35 U.S	.C. 118	
	iven Nan			N	Middle Name			Farr	nily Name	Suffix	
N	lichael Kiar	Shing						Tan			
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City Si	ngapore			Coun	try Of Re	sidencei	SG				
Citizensh	ip under	37 CFR 1.4	i (d)	SG							
Mailing A	ddress o	f Applicant:									
Address	1	Block 4	149, Hou	gang A	ve. 10, #06	5-513					
Address	2										
City	Singapo	re				Sta	te/Provi	nce			
Postal C	ode	53044)			Country	SG				
Applican	+ 6	'									
		ty •Inventor	OL	egal Re	presentativ	e under 35	U.S.C. 11	17	Party of Interest under 35 U.S.	C. 118	
	iven Nan		-1	N	liddle Na	me		Fam	nily Name	Suffix	
В	eng Chye							Chev	v	<u> </u>	
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City Si	nganore			Cour	try Of Re	eidencei	SG				

Citizenship under 37 CFR 1.41(b) i

SG

Application Data Sheet 37 CFR 1.76		Attorney Docket Number	MTI-31608
		Application Number	10/068, 159
Title of Invention	Stacked Die in Die BGA Pack	age	

Mailin	g Ac	dress of Ap	plicant:									
Addre	ss 1		Block 10	6, Tec	k Wr	nye Lane, #06	-504					
Addre	ss 2											
City		Singapore						State	/Provin	ce	SG	
Postal	Cod	ie	680106				Cou	ntryi	SG			
Applic												
Applic	ant	Authority 🖲	Inventor	Or	egal	Representativ	e unde	r 35 L	I.S.C. 11	7	Party of Interest under 35 U.S.	C. 118
Prefix	Giv	en Name				Middle Na	me			Family Name		Suffix
	Ch	eng Poh				Pour						
Resid	enc	Informatio	n (Select	One)	Ō	US Residenc	у () No	n US Res	idency	Active US Military Service	
City	Sing	ароге			Co	untry Of Re	siden	cei	SG			
Citize	nshi	under 37 C	FR 1.41(b) i	SG	3		·				
Mailin	g Ad	dress of Ap	plicant:									
Addre	ss 1		11 Flora	Road	#03-	06, Avlla Gard	lens					
Addre	ss 2											
City		Singapore						State	/Provin	ce		
Postal	Cod	le	509732				Cou	ntryi	SG			
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Correspondence Information:

opoaooo		
Enter either Customer For further information	Number or complete the Correspondence see 37 CFR 1.33(a).	e Information section below.
An Address is bei	ng provided for the correspondence Info	rmation of this application.
Customer Number	31870	
Email Address	jpolmatier@whdlaw.com	Add Email Remove Email

Application Information:

Title of the Invention	Stacked Die in Die	Stacked Die in Die BGA Package						
Attorney Docket Number	MTI-31608	MTI-31608 Small Entity Status Claimed						
Application Type	Nonprovisional							
Subject Matter	Utility							
Suggested Class (if any)			Sub Class (if any)	_				
Suggested Technology C	enter (if any)							
Total Number of Drawing	Sheets (if any)	14	Suggested Figure for Publication (if any) 4	1				

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MTI-31608

10/068,159

Attorney Docket Number

Application Number

Application Data Sheet 37 CFR 1.76

Stacked Die in Die BGA Package

Request Early Publication (Fee required at time of Request 37 CFR 1.219)

Title of Invention

Publication Information:

					4.4			
Representative	Information							
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Customer Number	31870							
application data sheet of (4), and need not other.	vise be made part of t			55 U.S.C. 119(e) 01				
Prior Application S	tatus Patented			*	R	Remove		
Application Number	Continuity Type		pplication mber	Filing Date (YYYY-MM-DD) Patent Number	Issue Date (YYYY-MM-DD)		
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oreign Priority	Information							
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and 37 CFR 1.55(a).					R	emove:		
Application Numb	er (Country i	F	Parent Filing Date	(YYYY-MM-DD)	Priority Claimed		
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ssignee Inform	nation:							
Providing this information of the CFR to have an a				titute for complianc	e with any requiremen	t of part 3 of Title 37		
Assignee 1								

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Application De	ta Sheet 37 CFR 1.76	Attorney Docket Number	MTI-31608					
Application Da	ita Sneet 37 CFR 1.76	Application Number	10/069,159					
Title of Invention	Stacked Die in Die BGA Pack	e in Die BGA Package						
Organization Name	9 Micron Technology, Inc.							
Mailing Address I	nformation:							
Address 1	8000 S. Federal Way	/						
Address 2								
City	Boise	State/Provi	ice ID	-				
Country US		Postal Code	83706-9632					
Phone Number		Fax Number						
Email Address			L					
Additional Assigne	e Data may be generated y	vithin this form by selecting	the Add					

button. Signature:

A signature of the applicant or representative is required in accordance with 37 CFR 1.33 and 10.18. Please see 37 CFR 1.4(d) for the form of the signature.								
Signature	1kms/ Kristuré l	Date (YYYY-MM-DD)	2007-05-04					
First Name	Kristine	Last Name	Strodthoff	Registration Number	34259			

This collection of information is required by 37 CFR 1.76. The information is required to obtain or retain a benefit by the public which is to fill (and by the USPTO to process) an application. Confidentially is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 23 minutes to complete, including algebring, preparing, and submitting the completed application data sheet form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Orlier Information Officer, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450, DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Pattents, P.O. Box 1450, Alexandria, VA 22313-1450.